

# RN00066

PN5190 B2 firmware release v03.06

Rev. 1.6 — 27 May 2025

Release notes

## Document information

Information	Content
Keywords	PN5190, PN5190 B2, NFC frontend controller
Abstract	Contains information about a specific release product and component information



## 1 Document purpose

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This document describes the tested functionality and limitations of the firmware PN5190 B2 FW v03.06.

It also describes the release summary, release history, known issues, work-arounds, limitations, and recommendations.

The functionality and limitations of the hardware and product support material (for example, customer development board and support software) are described in separate documents.

PN5190 B2 FW v03.06 is identical in features and functionality with PN5190 B1 FW v02.0B except for the firmware update (HDLL commands) which was updated for a crypto-assisted download to achieve higher security.

PN5190 B2 uses crypto-assisted download mode commands, where the opcodes are different compared with PN5190 B1 which uses the legacy download mode commands.

The user manual UM11942 (PN5190 instruction layer) explains the different opcodes used for download mode commands in detail.

## 2 PN5190 B2 firmware version information

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**PN5190 B2 software package version (including host utilities):** v03.06

**PN5190 B2 secure firmware version:** v03.06

**Note:** *This firmware version is meant only for the PN5190 B2 IC. This firmware cannot be used for the PN5190 B1 IC version.*

For new designs, it is recommended to always use the latest firmware version available.

### 3 Features supported in this release

This section provides the features supported in this firmware/software version release.

#### 3.1 RF protocols

Table 1. RF protocols

Feature/functionality
Reader mode A (106/212/424/848 kbit/s)
Reader mode B (106/212/424/848 kbit/s)
Reader mode FeliCa (212/424 kbit/s)
Reader mode ISO/IEC15693 (26/53/106/212Kbps) - all data rates as specified in data sheet
Reader mode ISO/IEC18000 3M3 - all data rates as specified in data sheet
Host card emulation / Card mode ISO/IEC 14443 A-106, A-212, A-424, A-848
Peer-Peer passive communication (ISO18092, PI106, PI212, PI424, PT106, PT212, PT424)
Peer-Peer passive communication with proprietary baud rates (PI212, PI424, PI848, PT212, PT424, PT848)

#### 3.2 Other system features/functionality protocols

Table 2. Other system features

Feature/functionality
Low-power card detection (LPCD) and ultra low-power card detection (ULPCD)
Dynamic power control
Automatic waveshape control
Automatic receiver control
Internal DC-DC for TX driver
Over temperature protection (automatic shutdown of TX drivers and entering low-power mode (Standby), over temperature event on GPIO)
Current limiter (automatic shutdown of TX drivers and event notification to host)
Supported to route analog and digital signal on AUX1(analog) and GPIO0 (digital).
Trimming of RF parameters (TX_NOV, current sensor, NFCLD, RFLD).

#### 3.3 Compliance with this firmware and PNEV5190B hardware (customer development board)

Table 3. Compliance with this firmware and PNEV5190B hardware (customer development board)

Feature/Functionality
EMVCo L1 digital compliance
ISO 10373-PCD digital compliance
ISO 10373-PICC digital compliance
NFC Forum CR11 analog and digital compliance. NFC Forum CR13 internally qualified.
ISO 23917 Peer-Peer Passive compliance

## 4 Version history

This section contains the firmware release version history.

The previously released hardware version had been **"B1"**.

The new hardware version is **"B2"**. There is no change in hardware functionality or software functionality features compared with **"B1"**.

Only the ROM code has been updated for the **"B2"** IC version.

The below table provides the firmware version history including feature updates and issues fixed.

**Table 4. Firmware updates from v03.05 to v03.06**

SI No.	Function/feature update
1	Fix for issue in the second MIFARE Classic authentication, seen only with a particular card, and seen only when the coupling between card and reader is strong enough.
2	Update in firmware to improve robustness during LPCD and Standby power modes.

**Table 5. Firmware updates from v03.04 to v03.05**

SI No.	Function/feature update
1	Added new LPCD command option which makes the IC enter LPCD mode and returns with an Autocoll Event if an external RF is detected. In SWITCH_MODE_LPCD(0x23) command, bControl field option LPCD_WITH_AUTOCOLL_EVENT (0x13) is added to support LPCD with Autocoll event when wake-up occurs due to load change/Ext RF from LPCD standby scenarios. Added EEPROM field to configure the time-out for Autocoll expiry: Name: LpcdWithAutocollExpiryInterval. Address Offset: 0xC EE Size: 1 Byte. Description: This field is the time before which Autocoll expires when LPCD is used with Autocoll option. 1unit - 100 ms. The default is 10 ms.
2	Added a new command CTS_FAST_CONFIGURE (0x2B) which both configures and enables CTS. For Enabling CTS, the Length should be 0x27(including both Configs and Enabling bytes). This command cannot be used for disabling CTS. First fast Init+Configure takes about 50 ms, second time onwards about 50 µs.
3	Added configuration to initialize the pullup/down state of SPI Pads (ATX Pins) in the secure flash init. This feature is disabled by default. Added the following EEPROM fields for reconfiguration of SPI pad configurations: Name: EnableHIFPadsReConfig. Address Offset: 0xC EF Size:1 Byte. Description: Enable/Disable reconfiguration of the SPI Pads configuration. Name: SPIPadReConfig. Address Offset: 0xC F0 Size: 4 Bytes. Description: SPI Pads PullUp/Down Configuration.
4	Fixed an issue which prevented exit from the Autocoll in some scenarios when external RF is removed.
5	Fixed an issue that caused changes in amplitude of response during Host Card emulation, when higher VDDPA Values are used in APC TX entries.

Table 6. Firmware updates from v03.03 to v03.04

SI No.	Function/feature update
1	Feature implemented DPR (Dynamic Power Regulation). Added new register DYNAMIC_POWERLEVEL_REG (Reg Addr: 0x64).
2	Feature implemented LFO timing calibration using frequency meter for higher LPCD pulse interval accuracy. Added new EEPROM setting LFO_TRIM_CALIBRATION ( EEPROM Addr:0xCED).
3	Updated the DPC algorithm for higher control accuracy.
4	Updated command GET_CRC_USER_AREA (Command code: 0x29).

Table 7. Firmware updates from v03.02 to v03.03

SI No.	Function/feature update
1	Resolved the issue of DPC not recovering to expected VDDPA regulation during load change conditions, when in some corner case scenarios the DPC has to manage other priority tasks.

Table 8. Firmware updates from v03.01 to v03.02

SI No.	Function/feature update
1	Fixed an issue where in increased leakage current in SPI_NSS (ATX_C) during low-power mode operation.

Table 9. Firmware updates from v03.00 to v03.01

SI No.	Function/feature update
1	Fixed an issue where in commands UPDATE_RF_CONFIGRUATION and GET_RF_CONFIGURATION commands when used for TX index 0x0F (ISO180003m3_TARI_18.88us) and 0x10 (ISO180003m3_TARI_9.44us).
2	Fixed an issue of not-restoring the analog TX settings when switching from reader mode to card mode. Removing of type-b detection during Autocoll. Supporting only Type-A and Type-F detection as part of Autocoll procedure.
3	Introduced a new EEPROM configuration: ENABLE_ULFO_TRIM_CALIBRATION (0xCEC). This configuration enables/disables the calibration of wake-up counter value based on the ULFO accuracy measured with frequency meter with Xtal as reference. <b>Note:</b> This feature must be used only when Xtal is available and configured for use
4	Deprecated the P2P active communication target mode functionality.

Table 10. Firmware updates in v03.00

SI No.	Function/feature update
1	All of the features and functionalities present in PN5190 B1 FW v02.06 is included in this FW version. In a nut-shell, below are incremental features are added in PN5190 B2 v03.00 and PN5190 B1 v02.06. <ul style="list-style-type: none"> <li>Added new command:GET_CRC_USER_AREA[0x29]: This command is used to calculate the CRC for the complete User area including Protocol area. This command helps customer to ensure the integrity of their RF and analog settings by detecting manipulation of this area.</li> <li>Modified SOF timing: In this FW version, we have modified the protocol settings of TypeB106 such that it supports SOF timing adjustment. We also provide better results during the EMVCo L1 analog test.</li> </ul>

## 5 Recommendations, known limitations, and precautions

This section provides the known limitations in the FW/HW recommendations

### 5.1 Known limitations

1. With the default FDT settings for ISO18000 (dwFDT\_18000\_DefVal parameter, which is 1.26 ms), performance @ -40 °C is reduced when TARI = 18.88  $\mu$ s.  
This shall be appropriately adjusted for better performance.
2. Randomly, PN5190 FW does not respond to the first REQA from an iPhone 12 Mini phone with HCE Mode + LPCD enabled.

### 5.2 Recommendations

The following clock parameters for Xtal are recommended for active communication on the customer development board PNEV5190B and 45 mm x 45 mm antenna.

Table 11. Recommendations for v03.00 and above

Address	Parameter name	Default value	Value for active communication
1	ANA_PLL_CTRL_XTAL	0x00	0xC1
2	ANA_PLL_CTRL_XTAL	0x8A	0x13
3	ANA_PLL_CTRL_XTAL	0xEA	0xE8
4	ANA_PLL_CTRL_XTAL	0xA6	0xA6

### 5.3 Precautionary notes

1. Do not disable the DPC and activate the RF field for IC's connected to antennas matched "Symmetric" (for example, customer development board antenna). Possible damage to the transmitter drivers due to overcurrent over a long period might occur.
2. PN5190 B1 samples cannot be upgraded with the PN5190 B2 FW.  
However, PN5190 B2 samples can be updated with this FW version.  
**Note:** The FW upgrade/downgrade to v03.02 (3.2) must be done in a power-stable environment. This is applicable for PN5190B2EV/C130 and PN5190B2HN/C130 parts only. PN5190B2EV/C131 and PN5190B2HN/C131 contain FW v03.02 (3.2) by default.
3. The ULPCD requires a specific power configuration with no DC-DC active and requires modifications to both the customer development board PNEV5190B EEPROM settings as described in the application notes.

6 Revision history

Table 12. Revision history

Document ID	Release date	Description
RN00066 v.1.6	27 May 2025	• PN5190 B2 firmware v03.06 release: <a href="#">Section 4 "Version history"</a> updated.
RN00066 v.1.5	9 Dezember 2024	• PN5190 B2 firmware v03.05 release: <a href="#">Section 4 "Version history"</a> updated.
RN00066 v.1.4	19 June 2024	• PN5190 B2 firmware v03.04 release: <a href="#">Section 4 "Version history"</a> updated.
RN00066 v.1.3	23 May 2024	• PN5190 B2 firmware v03.03 release: <a href="#">Section 4 "Version history"</a> updated.
RN00066 v.1.2	7 November 2023	• PN5190 B2 firmware v03.02 release: <a href="#">Section 4 "Version history"</a> updated.
RN00066 v.1.1	8 September 2023	• PN5190 B2 firmware v03.01 release: <a href="#">Section 4 "Version history"</a> updated.
RN00066 v.1.0	3 May 2023	• PN5190 B2 firmware v03.00 release: <a href="#">Section 4 "Version history"</a> updated.



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Tables

Tab. 1.	RF protocols .....	4	Tab. 6.	Firmware updates from v03.03 to v03.04 .....	6
Tab. 2.	Other system features .....	4	Tab. 7.	Firmware updates from v03.02 to v03.03 .....	6
Tab. 3.	Compliance with this firmware and PNEV5190B hardware (customer development board) .....	4	Tab. 8.	Firmware updates from v03.01 to v03.02 .....	6
Tab. 4.	Firmware updates from v03.05 to v03.06 .....	5	Tab. 9.	Firmware updates from v03.00 to v03.01 .....	6
Tab. 5.	Firmware updates from v03.04 to v03.05 .....	5	Tab. 10.	Firmware updates in v03.00 .....	6
			Tab. 11.	Recommendations for v03.00 and above .....	7
			Tab. 12.	Revision history .....	8

Contents

1 Document purpose .....2

2 PN5190 B2 firmware version information .....3

3 Features supported in this release .....4

3.1 RF protocols .....4

3.2 Other system features/functionality protocols .....4

3.3 Compliancy with this firmware and PNEV5190B hardware (customer development board) .....4

4 Version history .....5

5 Recommendations, known limitations, and precautions .....7

5.1 Known limitations .....7

5.2 Recommendations .....7

5.3 Precautionary notes .....7

6 Revision history .....8

Legal information .....9

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